SS1045 THRU SS10100

10.0 AMP SURFACE MOUNT SCHOTTKY BARRIER RECTIFIERS

VOLTAGE RANGE
45 to 100 Volts
CURRENT
10.0 Ampere

FEATURES

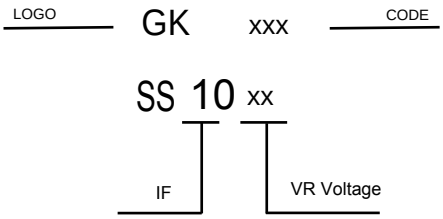
* Ideal for surface mount applications
* Easy pick and place
* Built-in strain relief
* Low forward voltage drop





MECHANICAL DATA

* Case: Molded plastic
* Epoxy: UL 94V-0 rate flame retardant
* Terminals: Solder plated, solderable per MIL-STD-202F method 208 guranteed
* Polarity: Color band denotes cathode end
* Mounting position: Any



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Rating 25°C ambient temperature uniess otherwies specified.
Single phase half wave, 60Hz, resistive or inductive load.
For capacitive load, derate current by 20%.

TYPE NUMBER	SS1045	SS1060	SS10100	UNITS
Maximum Recurrent Peak Reverse Voltage	45	60	100	V
Maximum RMS Voltage	32	42	70	V
Maximum DC Blocking Voltage	45	60	100	V
Maximum Average Forward Rectified Current See Fig. 1	10.0			A
Peak Forward Surge Current, 8.3 ms single half sine-wave superimposed on rated load (JEDEC method)	175			A
Maximum Instantaneous Forward Voltage at 10.0A	0.55	0.7	0.85	V
Maximum DC Reverse Current Ta=25°C	0.1		0.02	mA
at Rated DC Blocking Voltage Ta=100°C	5		2	mA
Typical Junction Capacitance (Note1)	400			pF
Typical Thermal Resistance R JL (Note 2)	16			°C/W
Operating Temperature Range T_J	-55 to +150			°C
Storage Temperature Range T_{STG}	-55 to +150			°C

NOTES:

1. Measured at 1MHz and applied reverse voltage of 4.0V D.C.

2. Thermal Resistance Junction to Lead.

RATING AND CHARACTERISTIC CURVES

FIG.1-TYPICAL FORWARD CURRENT DERATING CURVE

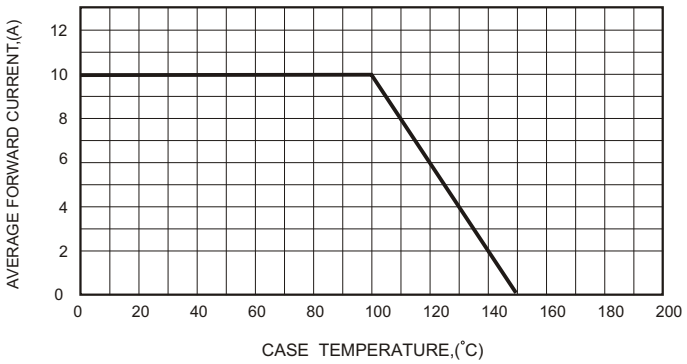


FIG.2-TYPICAL FORWARD CHARACTERISTICS

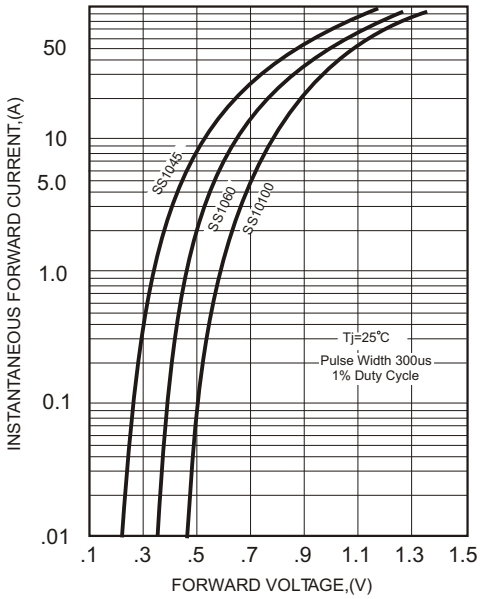


FIG.3 - TYPICAL REVERSE CHARACTERISTICS

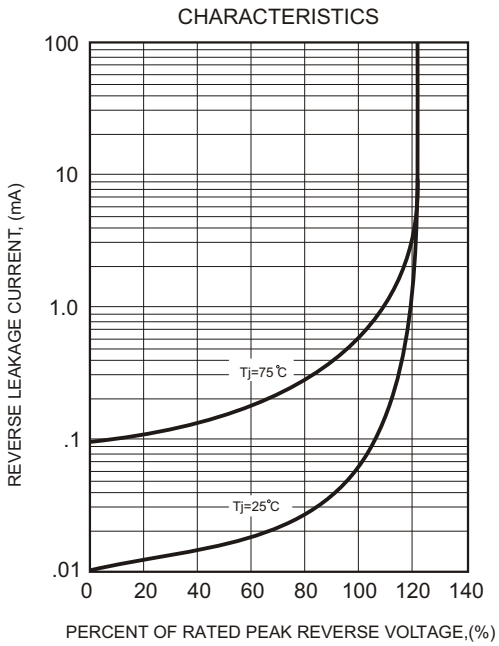


FIG.4-MAXIMUM NON-REPETITIVE FORWARD SURGE CURRENT

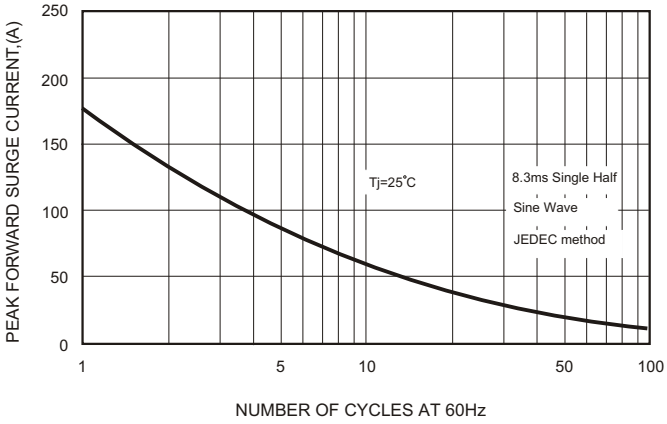
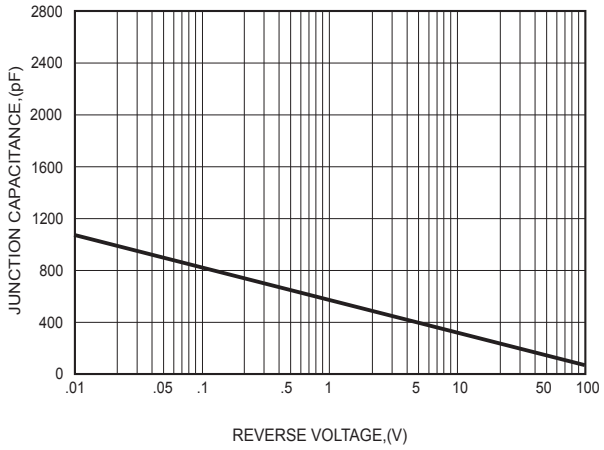


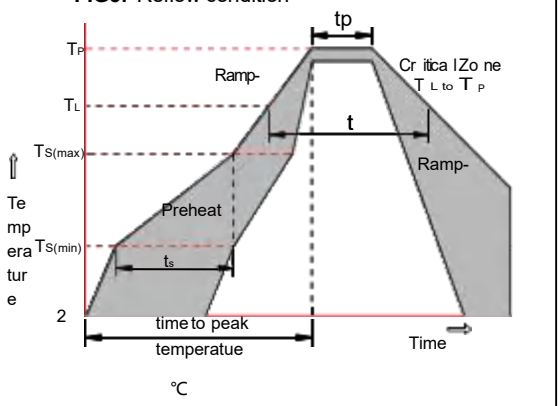
FIG.5-TYPICAL JUNCTION CAPACITANCE



Soldering parameters

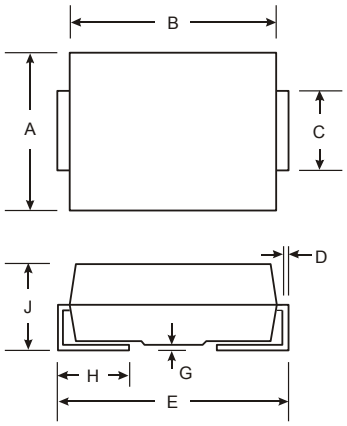
Reflow Condition		Pb-Free assembly (see as bellow)
Pre Heat	-Temperature Min ($T_{s(min)}$)	+150℃
	-Temperature Max($T_{s(max)}$)	+200℃
	-Time (Min to Max) (ts)	60-180 secs.
Average ramp up rate (Liquid us Temp (T_L) to peak)		3℃/sec. Max
$T_{s(max)}$ to T_L - Ramp-up Rate		3℃/sec. Max
Reflow	-Temperature(T_L)(Liquid us)	+217℃
	-Temperature(t_L)	60-150 secs.
Peak Temp (T_p)		+260(+0/-5)℃
Time within 5℃ of actual Peak Temp (t_p)		30 secs. Max
Ramp-down Rate		6℃/sec. Max
Time 25℃ to Peak Temp (T_P)		8 min. Max
Do not exceed		+260℃

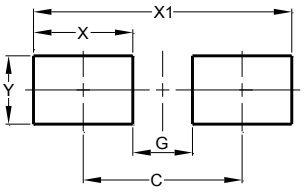
FIG5: Reflow condition



Package Dimensions & Suggested Pad Layout

SMB



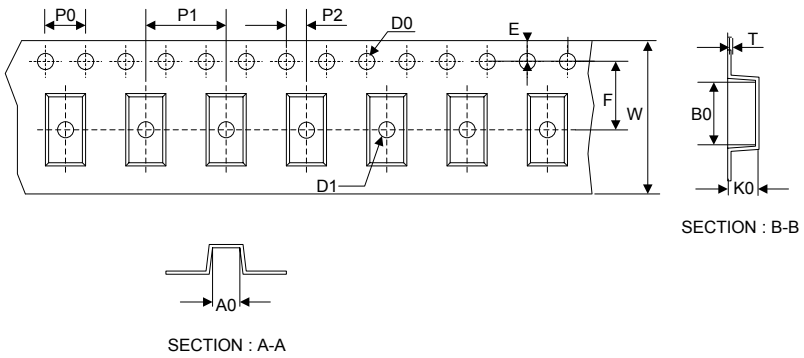


SMB		
Dim	**Min**	**Max**
A	3.30	3.94
B	4.06	4.70
C	1.91	2.11
D	0.15	0.31
E	5.08	5.59
G		0.20
H	0.76	1.50
J	2.13	2.44
All Dimensions in mm		

Dimensions	Value (in mm)
C	4.70
G	2.20
X	2.50
X1	7.20
Y	2.80

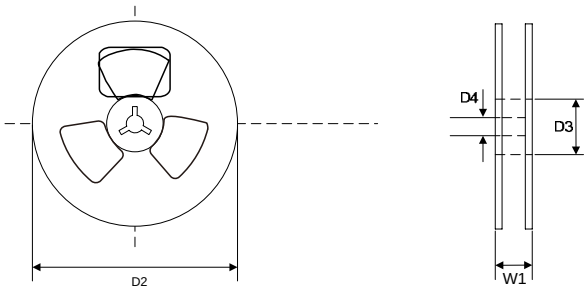
Tape & rell specification

Tape



Symbol	Dimension (mm)
P0	4.00±0.20
P1	8.00±0.20
P2	2.00±0.20
D0	1.60±0.20
D1	1.60±0.20
E	1.75±0.20
F	5.50±0.15
W	12.00±0.20
A0	4.00±0.20
B0	5.45±0.20
K0	2.50±0.25
T	0.20±0.10

13” Reel



D2	330.0±5.0
D3	73.0Min.
D4	14.0±2.5
W1	16.0±2.5
Quantity: 3000PCS	